

Voltage Ratings

Parameters	22GQ100
V_R Max. DC Reverse Voltage (V)	100
V_{RWM} Max. Working Peak Reverse Voltage (V)	

Absolute Maximum Ratings

Parameters	Limits	Units	Conditions
$I_{F(AV)}$ Max. Average Forward Current See Fig. 5	30	A	50% duty cycle @ $T_C = 113^\circ\text{C}$, rectangular waveform
I_{FSM} Max. Peak One Cycle Non - Repetitive Surge Current	400	A	@ $t_p = 8.3$ ms half-sine

Electrical Specifications

Parameters	Limits	Units	Conditions
V_{FM} Max. Forward Voltage Drop See Fig. 1 ①	0.86	V	@ 20A $T_J = -55^\circ\text{C}$
	0.99	V	@ 35A $T_J = -55^\circ\text{C}$
	0.84	V	@ 20A $T_J = 25^\circ\text{C}$
	0.98	V	@ 35A $T_J = 25^\circ\text{C}$
	0.73	V	@ 20A $T_J = 125^\circ\text{C}$
I_{RM} Max. Reverse Leakage Current See Fig. 2 ①	0.8	mA	$T_J = 25^\circ\text{C}$ $V_R = \text{rated } V_R$
	45	mA	$T_J = 125^\circ\text{C}$ $V_R = \text{rated } V_R$
C_T Max. Junction Capacitance	1400	pF	$V_R = 5V_{DC}$ (1MHz, 25°C)
L_S Typical Series Inductance	7.8	nH	Measured from anode lead to cathode lead 6mm (0.025 in.) from package

Thermal-Mechanical Specifications

Parameters	Limits	Units	Conditions
T_J Max. Junction Temperature Range	-55 to 150	$^\circ\text{C}$	
T_{stg} Max. Storage Temperature Range	-55 to 150	$^\circ\text{C}$	
R_{thJC} Max. Thermal Resistance, Junction to Case	1.0	$^\circ\text{C}/\text{W}$	DC operation See Fig. 4
wt Weight (Typical)	9.3	g	
Die Size	200X200	mils	
Case Style	TO-254AA		

① Pulse Width < 300 μs , Duty Cycle < 2%

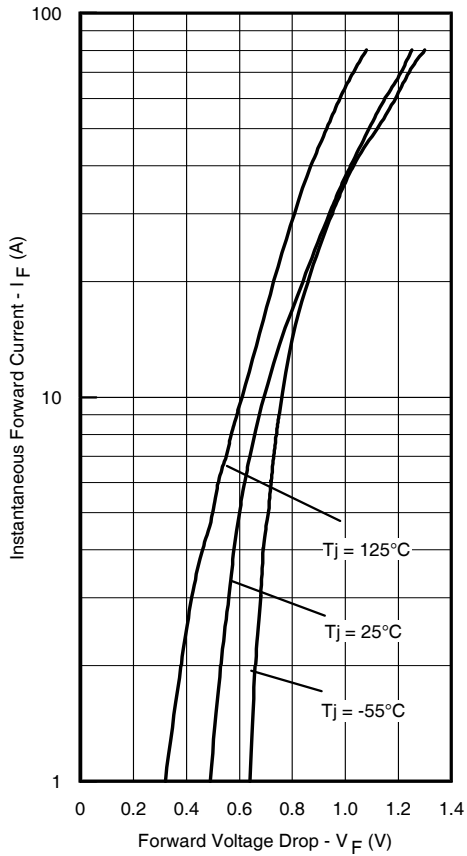


Fig. 1 - Maximum Forward Voltage Drop Characteristics

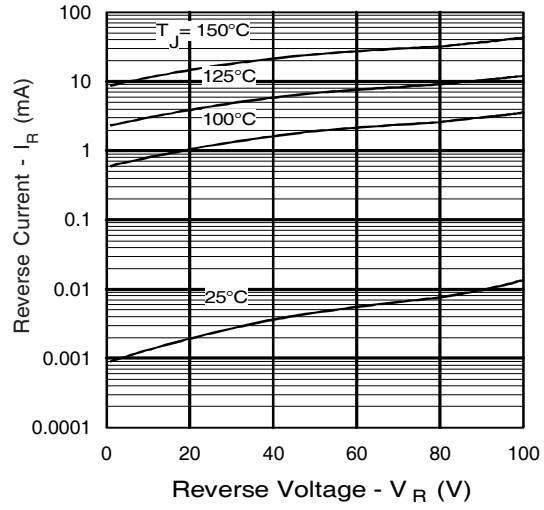


Fig. 2 - Typical Values of Reverse Current Vs. Reverse Voltage

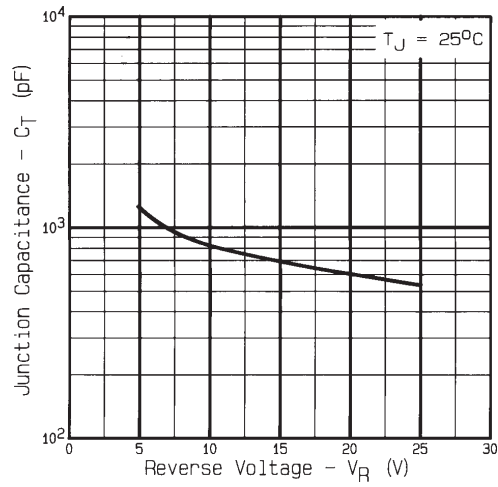


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage

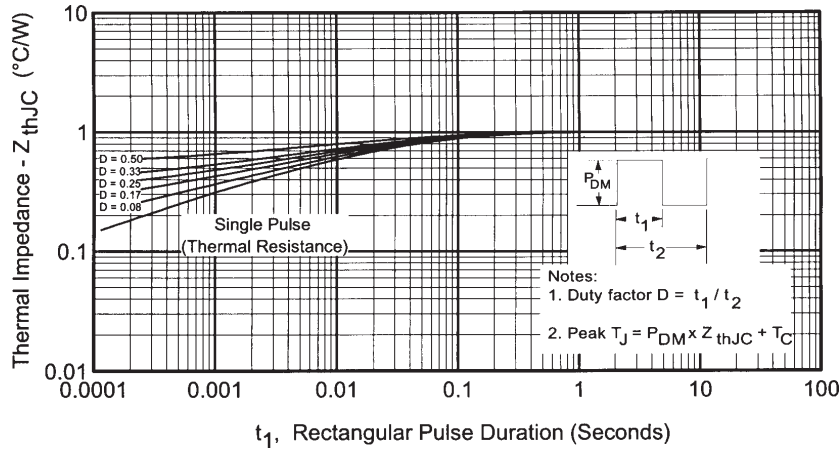


Fig. 4 - Max. Thermal Impedance Z_{thJC} Characteristics

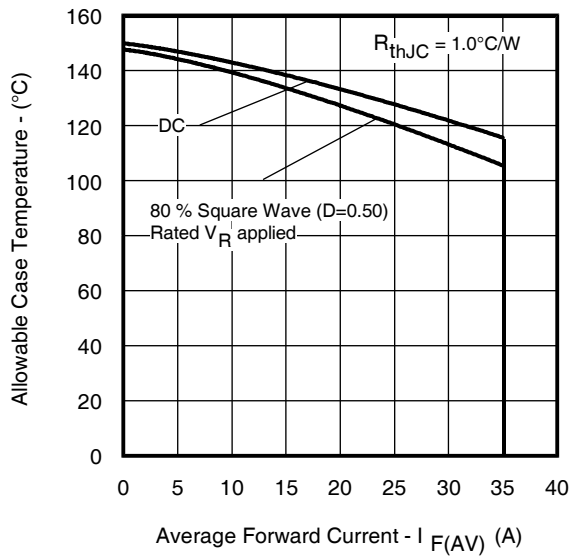


Fig. 5 - Max. Allowable Case Temperature Vs. Average Forward Current